



Accellera, Standards, and Semiconductor Supply Chain

Lu Dai
Accellera Chair



Lu Dai - Bio

Lu Dai is a Senior Director of Technical Standards at Qualcomm Technologies, Inc., spearheading semiconductor standards efforts and relationships with industry organizations.

Lu was previously Senior Director of Engineering and led Qualcomm's SOC design verification team and front-end methodologies and initiatives. He was also the Design Verification Lead responsible for multiple generations of premium tier platforms at Qualcomm, including the Snapdragon 8 series and products that power the Mars Perseverance rover and Ingenuity helicopter.

Prior to Qualcomm, Lu was the Design Verification Lead for Cisco's Gigabit Switching Business Unit where he worked on multiple generations of Cat4k ASICs.

Lu is the current Chair of Accellera, Chairman of the RISC-V International Board of Directors and serves on the Board of Directors at Si2.

Lu holds a Master's degree in Electrical Engineering from Cornell, and a Bachelor's in Electrical Engineering and Computer Science from UC Berkeley.

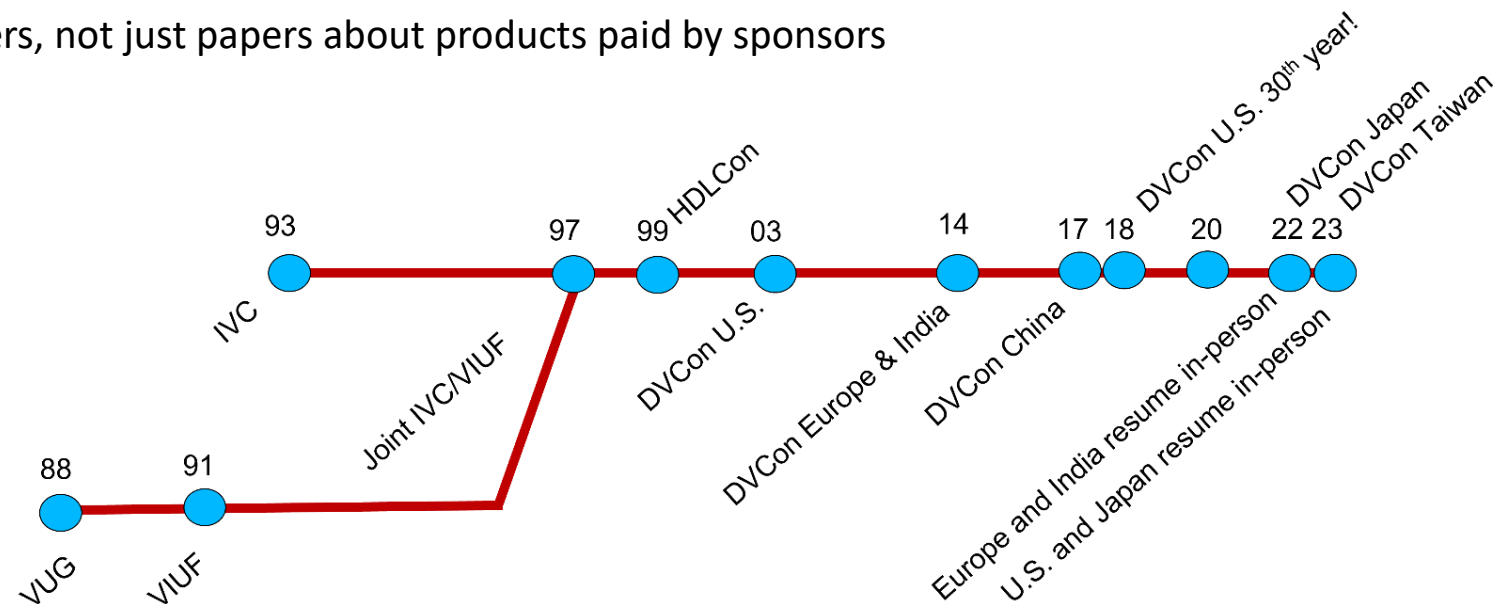


Accellera History

- Accellera Systems Initiative is an independent, not-for profit organization dedicated to create, support, promote, and advance system-level design, modeling, and verification standards for use by the worldwide electronics industry.
- Accellera supports a mix of user and vendor standards and open interfaces development in the area of electronic design automation (EDA) and intellectual property (IP).
- Through an ongoing partnership with the IEEE, standards and technical implementations developed by Accellera are contributed to the IEEE for formal standardization and ongoing governance.
- 1991: Open Verilog International (OVI) and VHDL International (VI) founded separately
- 2000: OVI and VI merged to form Accellera Organization
- 2009: Accellera merged with The SPIRIT Consortium
- 2011: Accellera merged with Open SystemC Initiative (OSCI) and changed its name to Accellera Systems Initiative
- 2013: Accellera acquired Open Core Protocol (OCP) standard, the intellectual property of the OCP International Partnership (OCP-IP)

DVCon History

- Accellera has been successfully sponsoring Design & Verification Conference & Exhibition in the US for 35+ years
- Original events had different names and were tied to VHDL International and Open Verilog International
- Eventually VHDL and Verilog-focused groups merged into a single conference and became DVCon in 2003
- Global expansion started in 2014: DVCon Europe, DVCon India, DVCon China, DVCon Japan, and DVCon Taiwan
- Every DVCon has a similar “Look & Feel” with a focus on user contribution
 - Papers written by and presented by users, not just papers about products paid by sponsors
 - Panel sessions on current hot topics
 - Tutorials related to relevant standards



Accellera Standards

Corporate IEEE Member

IEEE IPR adopted

Merger with SPIRIT

Merger with OSCI

Acquired OCP

		2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015	2016	2017	2018	2019	2020	2021	2022	2023					
Design - Analog & Digital	SystemC Lang.	2.1	IEEE 1666-2005					IEEE 1666-2011															IEEE 1666-2022			
	SC-AMS								1.0		2.0	IEEE P1666.1														
	SC-TLM	1.0	2.0					Merged into IEEE 1666-2011																		
	SC-Verif.								1.0				2.0	2.0.1												
	SystemVerilog	3.1a	IEEE 1800-2005				IEEE 1800-2009				IEEE 1800-2012				IEEE 1800-2017											
	Verilog AMS	2.2	2.3				2.3.1				2.4															
	VHDL		1.0	3.0	3.1	4.0	IEEE 1076-2009							IEEE 1076-2019												
Verification - Analog & Digital	OVL		1.0	1.8	2.1	2.3	2.4	2.5	2.6	2.7	2.8.1															
	PSL	1.1	IEEE 1850-2005					IEEE 1850-2010																		
	PSS																1.0	1.0a	2.0							
	UCIS																					1.0				
	UVM																						1.0 & 1.1	1.2	IEEE 1800.2-2017	IEEE 1800.2-2020
Integration - Infrastructure	Functional Safety																									White Paper
	IP-XACT		1.5				IEEE 1685-2009					IEEE 1685-2014										IEEE 1685-2022				
	IPSA																									SA-EDI 1.0
	IP Tagging																									1.0
	OCP																									3.0
	SCE-MI		1.1	2.0	2.1			2.2			2.3	2.4														
	SystemRDL																								1.0	2.0
UPF			1.0	IEEE 1801-2008					IEEE 1801-2013			IEEE 1801-2015			IEEE 1802-2018											



Accellera-IEEE Collaboration

IEEE

- [VHDL](#) or IEEE 1076 or IEC 61691-1-1
- [Verilog](#) or IEEE 1364 or IEC 61691-4
- Delay and Power Calculation System (DPCS/OLA: [Standard Parasitic Exchange Format](#)) or IEEE 1481
- [Standard Delay Format](#) (SDF) or IEEE 1497 or IEC 61523-3
- Open Model Interface (OMI) or IEEE 1499
- Open Compression Interface (OCI) or IEEE 1450.6.1
- [Advanced Library Format](#) (ALF) or IEEE 1603 or IEC 62265
- [SystemC](#) or IEEE 1666
- SystemC Analog/Mixed-Signal extensions or IEEE 1666.1
- [IP-XACT](#) or IEEE 1685
- [SystemVerilog](#) or IEEE 1800
- [Unified Power Format](#) (UPF) or IEEE 1801
- [Universal Verification Methodology](#) (UVM) or IEEE 1800.2
- [Property Specification Language](#) (PSL) or IEEE 1850 or IEC 62531

Accellera

- [IP Security Assurance](#) (Security Annotation for Electronic Design Integration (SA-EDI))
- [Open Core Protocol](#) (OCP)
- [Open Verification Library](#) (OVL)
- [Portable Test & Stimulus Standard](#) (PSS)
- [Standard Co-Emulation-Modeling Interface](#) (SCE-MI)
- [Soft IP Tagging](#)
- [SystemRDL](#) (System Register Description Language)
- [Unified Coverage Interoperability Standard](#) (UCIS)
- [Verilog-AMS](#) (Analog Mixed-Signal)

Accellera Members

Corporate Members



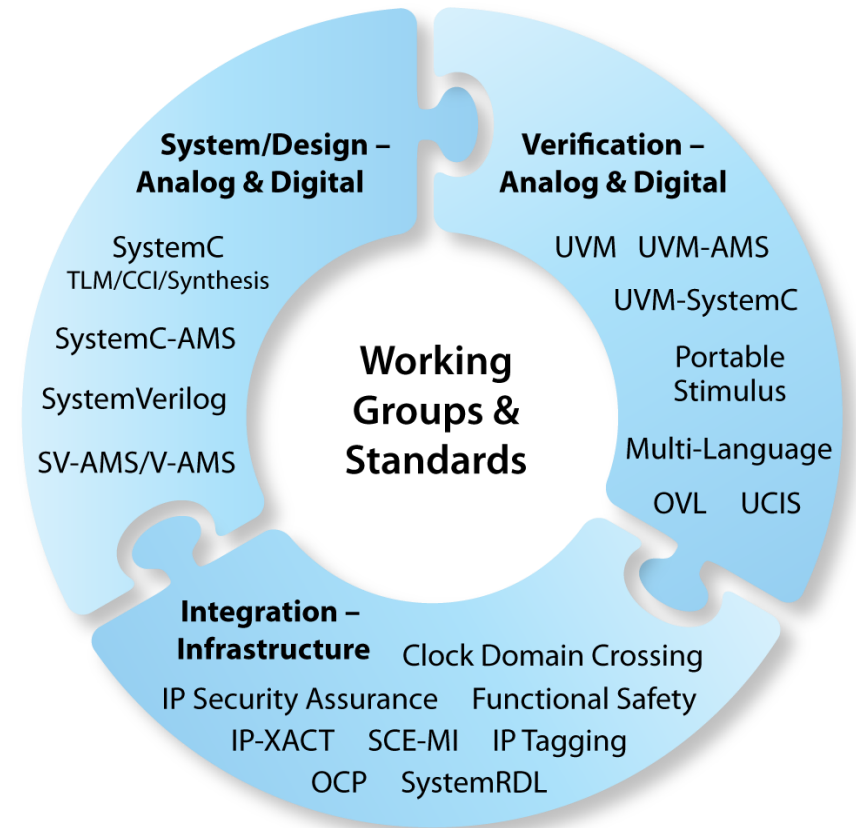
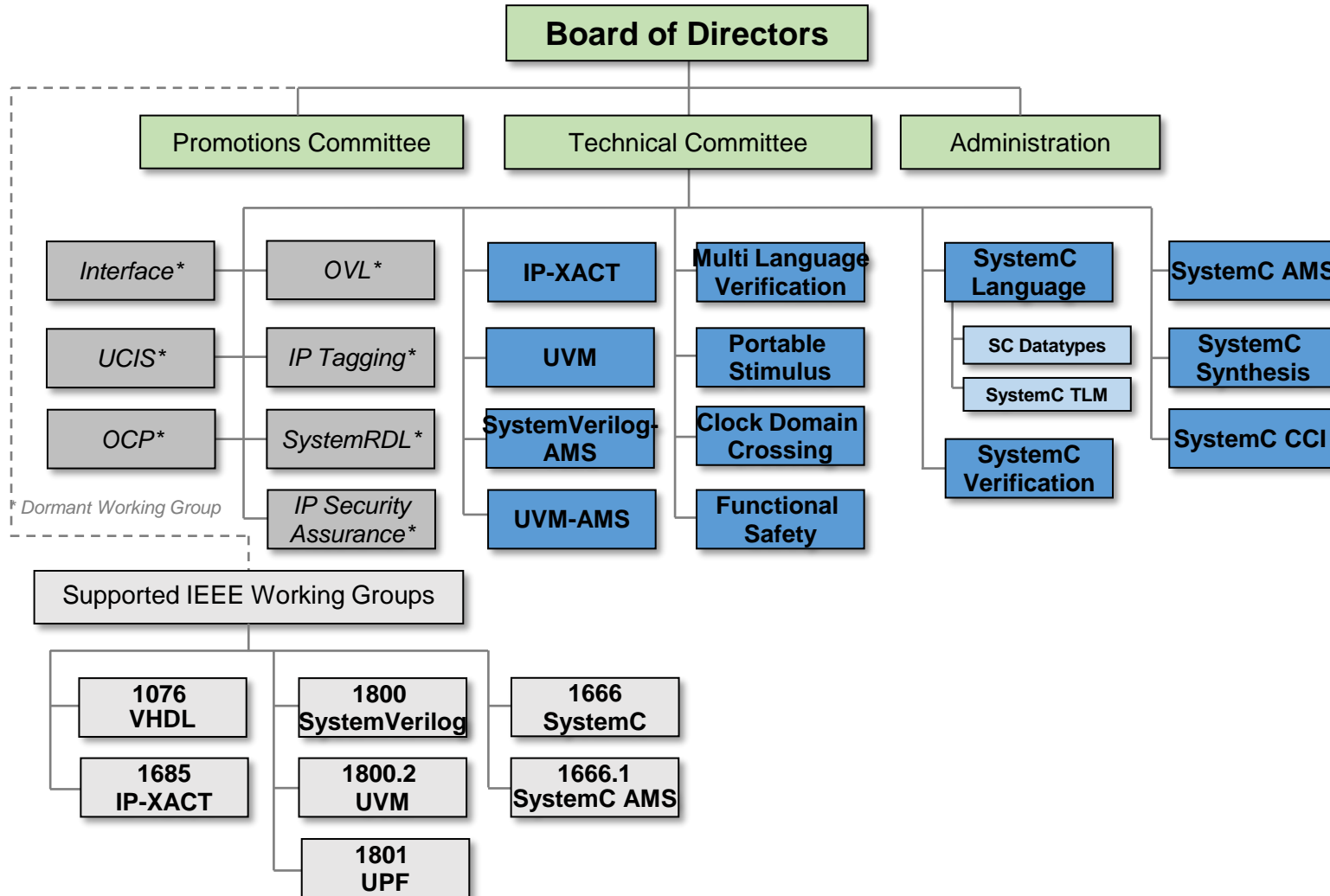
Start-Up and University



Associate Members



Accellera Activities





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Years of driving the evolution of wireless

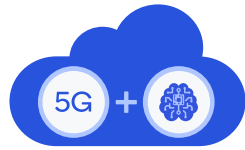
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Fabless semiconductor company

Qualcomm



Foundational
R&D



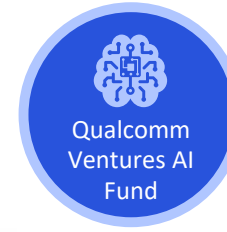
5G + AI technology
leadership



Systems
design
expertise



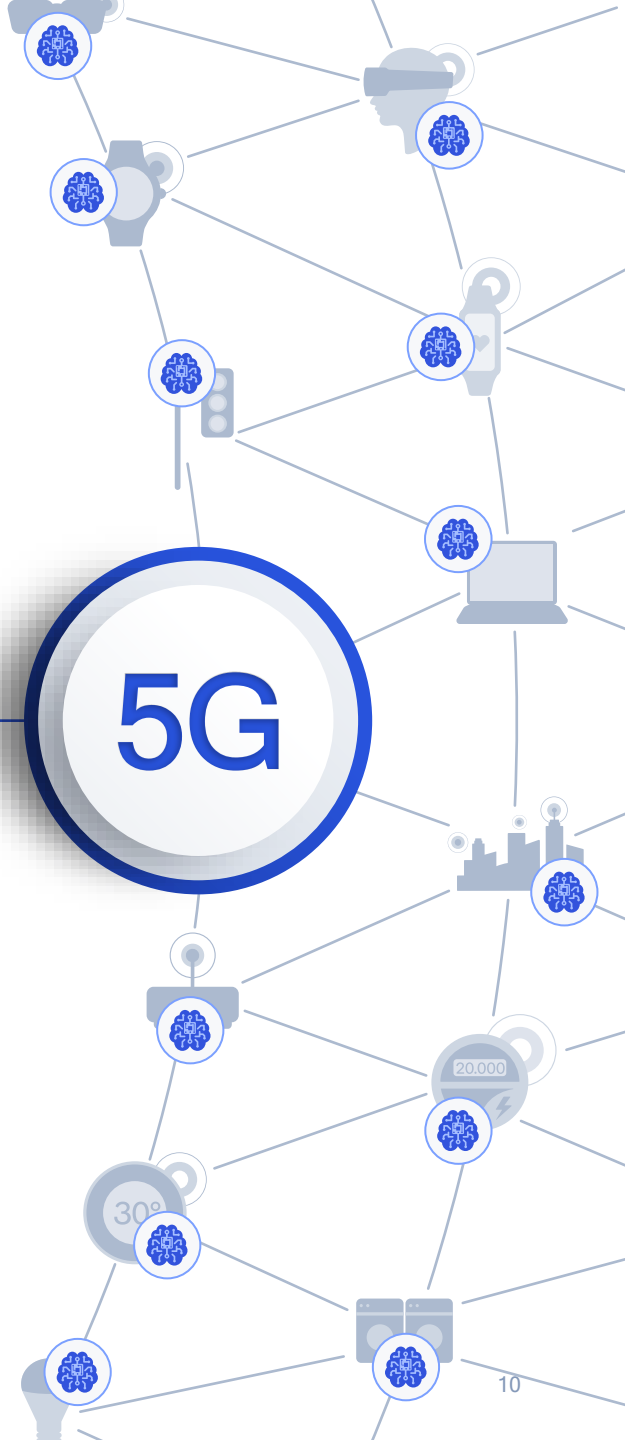
Advanced
silicon



Ecosystem
investment



Uniquely positioned to power the
intelligently connected future





We participate in

~200 global

standards and industry organizations

Qualcomm

What are standards?

- Regulations
 - “mandatory”
- Standards
 - Voluntary
 - In some parts of the world, developed by a formally recognized standards body
 - i.e., in Europe: CEN, CENELEC, or ETSI
 - In US, developed by an ANSI accredited standards body
- Specifications

Voluntary Consensus Standards

- Voluntary Consensus Standards Body
US OMB A.119 Requirements

- i. Openness
- ii. Balance
- iii. Due process
- iv. Appeals process
- v. Consensus

- OpenStand – Principles

- i. Due process
- ii. Broad consensus
- iii. Transparency
- iv. Balance
- v. Openness

- Adherence to these facilitates competition and reduces anti-trust concerns
- Similar rules are codified in the WTO (World Trade Organization) TBT (Technical Barriers to Trade) Agreements
 - “technical regulations”, “conformity assessment procedures”, and “standards” are not prepared, adopted or applied with a view to, or with the effect of, creating **unnecessary** obstacles to international trade.
 - However, allow some carve out for “inter alia: **national security requirements**; the prevention of deceptive practices; protection of human health or safety, animal or plant life or health, or the environment.”

Patents: SEPs and FRAND

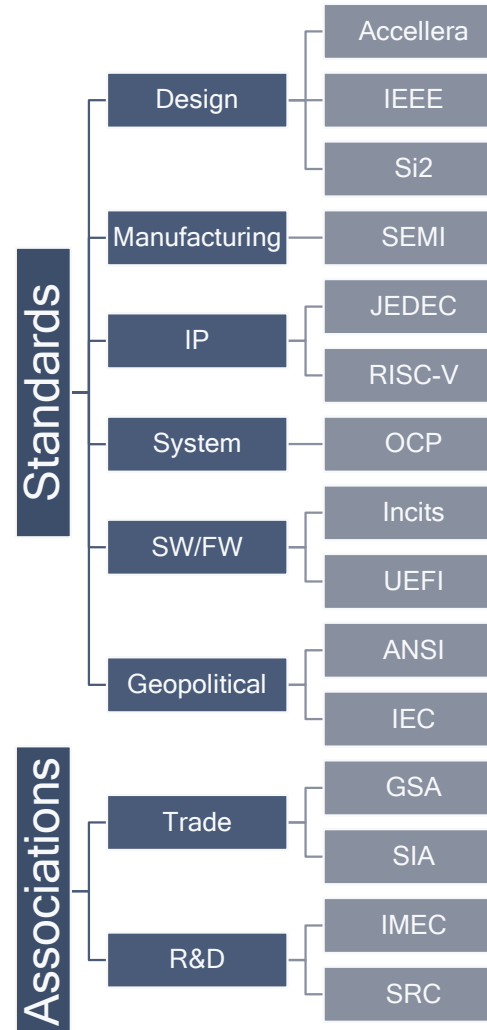
- SEP – Standards Essential Patent
- FRAND (also RAND) – Fair Reasonable and non-Discriminatory
- RF – Royalty Free
- LoA – Letter of Assurance
 - Letter of commitment to license SEPs under SDO IP policy
- Patent Declarations
 - Indicate SEPs
 - Often the terminology is considered interchangeable with LoA, but actual usage depends on the actual text used in the IP Policy itself

Our industry is based on technology standards



Standards create significant value for the technology ecosystem

What are semiconductor standards



What is semiconductor supply chain

- [From Investopedia] A supply chain is a network of individuals and companies who are involved in creating a product and delivering it to the consumer. Links on the chain begin with the producers of the raw materials and end when the van delivers the finished product to the end user.
- [Supply chain management](#) is a crucial process because an optimized supply chain results in lower costs and a more efficient production cycle. Companies seek to improve their supply chains so they can reduce their costs and remain competitive.
- The semiconductor [supply chain](#) refers to the network of companies involved in their design, manufacturing, testing, packaging, and distribution. The supply chain is complex, involving the coordination of a number of different stages, from sourcing parts and materials to the sale to the final end user.

Supply Chain Challenges



What changed?

Covid

Geopolitical events



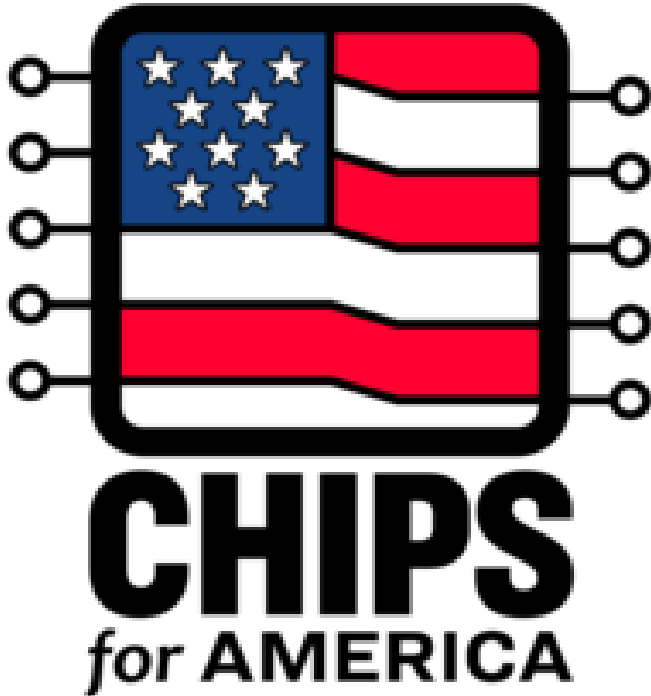
How bad?

Supply chain constrain

Supply chain disruption

- Supply chain rewire
 - Reliability (quality)
 - Security (safety)
 - Resiliency (risk management)
 - Diversity (options)
 - Sustainability (time)

CHIPS Act(s) and Rise of National Standards



- The CHIPS and Science Act of 2022 calls for a 5yr \$52.7B congressional funding to revitalize United States semiconductor industry
- There are international CHIPS Act in the work as well, including EU (€43B), South Korea (15-25% tax deduction), and Taiwan (NT\$6B), among others
- MIIT released a proposal to establish a new “National Integrated Circuit Standardization Technical Committee.” The committee would research, develop, and revise standards for all types and components of semiconductors, including integrated circuit materials and equipment, semiconductors, integrated circuit module, integrated circuit chips, and micro-electromechanical systems (MEMS)

A New Hope



While countries want disengagement for supply chain security, the world wants interdependency for preserving peace

A semiconductor détente?

International standards help ensure interoperability of an interdependent ecosystem



Supply chain interdependency = a new foundation for world peace

Questions

